INFORMATION DISCLOSURE CITATION (Use several sheets if necessary)

Docket Number (Optional) TWI-30510	Application Number NEW
Applicant(s) Kenneth C. Johnson et al.	
Filing Date	Group Art Unit
HEREWITH	Unknown

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·	I	DOCUMENT					TRANS	LATION
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Examiner	Call M. J;	Date Considered 17/14/04
Examiner:	Initial if citation considered, whether or not citation is i	in conformance with MPEP Section 609; Draw line through citation if
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Examiner Culf W. 2 Date Considered 7/14/04

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